

## **CURING METHOD AND APPARATUS**

### **Abstract**

The present invention provides a method for curing a light curable sealant in an article. The article includes opposing first and second substrates. The light curable sealant is used to attach the first substrate to the second substrate. The method includes irradiating steps (a) and (b). In the step (a), the article is irradiated by a light entering the article from the first substrate to reach the light curable sealant. In the step (b), the article is irradiated by a light entering the article from the second substrate to reach the light curable sealant. The present invention further provides curing apparatuses for accomplishing the aforementioned method.